



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Connell et al.

Serial No.: 10/706,212

Filed: November 12, 2003

For: WAFER BACK SIDE COATING TO  
BALANCE STRESS FROM PASSIVATION  
LAYER ON FRONT OF WAFER AND BE  
USED AS A DIE ATTACH ADHESIVE

Confirmation No.: 6326

Examiner: G. Eckert II

Group Art Unit: 2815

Attorney Docket No.: 2269-5083.1US  
(01-0428.01/US)

PATENT

*Am B*  
*W. Eckert*  
*W. Eckert*  
*8/23/05*  
*T. Howard*  
*9/1/05*

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

August 1, 2005  
Date

*Leta M. Howard*  
Signature

Leta M. Howard  
Name (Type/Print)

AMENDMENT UNDER 37 C.F.R. § 1.116

MAIL STOP AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The following amendments and remarks are filed in response to the Examiner's remarks in the Final Office Action mailed June 1, 2005, the three-month shortened statutory period for response to which expires on September 1, 2005. This response is submitted on or before two months from the mailing date of the Final Office Action.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Remarks/Arguments** begin on page 8 of this paper.